

# US3A THRU US3M

## SURFACE MOUNT ULTRA FAST RECTIFIER

Reverse Voltage - 50 to 1000 Volts   Forward Current - 3.0 Amperes

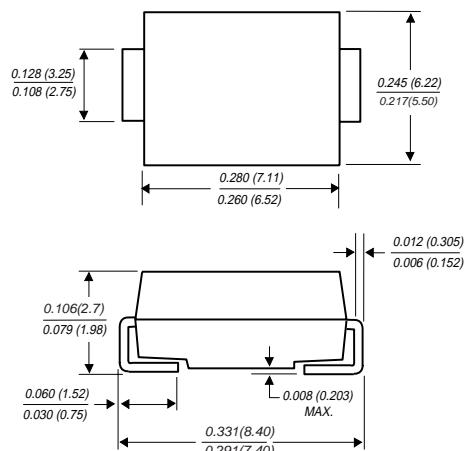
### FEATURES

- Ideal for surface mount pick and place application
- Low profile package
- Built-in strain relief
- High surge capability
- Glass passivated chip
- Ultra fast recovery for high efficiency
- High temperature soldering guaranteed: 260°C/10sec/at terminal

### MECHANICAL DATA

- Terminal: Plated leads solderable per MIL-STD 202E, method 208C
  - Case: Molded with UL-94 Class V-O recognized flame retardant epoxy
  - Polarity: Color band denotes cathode
- Weight:** 0.22 grams

DO-214AB



Dimensions in inches and (millimeters)

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Single-phase, half-wave, 60Hz, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%)

RATINGS	SYMBOL	US 3A	US 3B	US 3D	US 3G	US 3J	US 3K	US 3M	UNITS
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (T <sub>L</sub> =75°C)	I <sub>F(AV)</sub>								A
Peak Forward Surge Current (8.3ms single half sine-wave superimposed on rated load)	I <sub>FSM</sub>								A
Maximum Instantaneous Forward Voltage (at rated forward current)	V <sub>F</sub>		1.0		1.3		1.7		V
Maximum DC Reverse Current T <sub>a</sub> =25°C (at rated DC blocking voltage) T <sub>a</sub> =100°C	I <sub>R</sub>				10.0		250		µA
Maximum Reverse Recovery Time (Note 1)	trr		50			75			nS
Typical Junction Capacitance (Note 2)	C <sub>J</sub>			45					pF
Typical Thermal Resistance (Note 3)	R <sub>θ(ja)</sub>			25					°C/W
Storage and Operation Junction Temperature	T <sub>STG,T<sub>J</sub></sub>				-50 to +150				°C

Note:

- 1.Reverse recovery condition I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A,I<sub>rr</sub>=0.25A.
- 2.Measured at 1.0 MHz and applied voltage of 4.0V<sub>dc</sub>
- 3.Thermal resistance from junction to terminal mounted on 0.6"x0.6" ( 16 x 16 mm ) copper pad area

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